General Purpose Transistors

NPN Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	40	Vdc
Collector - Base Voltage	V _{CBO}	60	Vdc
Emitter - Base Voltage	V _{EBO}	6.0	Vdc
Collector Current - Continuous	Ic	600	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

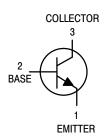
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

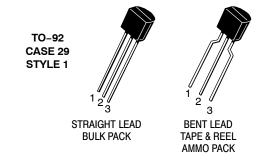
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



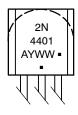
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MARKING DIAGRAM



2N4401 = Device Code = Assembly Location

= Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

	Characte	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS				•	•	•
Collector-Emitter Breakdow	V _{(BR)CEO}	40	-	Vdc		
Collector-Base Breakdown	Voltage	$(I_C = 0.1 \text{ mAdc}, I_E = 0)$	V _{(BR)CBO}	60	-	Vdc
Emitter-Base Breakdown V	oltage	(I _E = 0.1 mAdc, I _C = 0)	V _{(BR)EBO}	6.0	-	Vdc
Base Cutoff Current		(V _{CE} = 35 Vdc, V _{EB} = 0.4 Vdc)	I _{BEV}	-	0.1	μAdc
Collector Cutoff Current		(V _{CE} = 35 Vdc, V _{EB} = 0.4 Vdc)	I _{CEX}	-	0.1	μAdc
ON CHARACTERISTICS (N	lote 1)					
DC Current Gain		$ \begin{array}{l} (I_{C}=0.1 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=1.0 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=10 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=150 \text{ mAdc, } V_{CE}=1.0 \text{ Vdc}) \\ (I_{C}=500 \text{ mAdc, } V_{CE}=2.0 \text{ Vdc}) \end{array} $	h _{FE}	20 40 80 100 40	- - 300 -	-
Collector – Emitter Saturation Voltage $ \begin{array}{c} \text{(I}_{C} = 150 \text{ mAdc, I}_{B} = 15 \text{ mAdc)} \\ \text{(I}_{C} = 500 \text{ mAdc, I}_{B} = 50 \text{ mAdc)} \end{array} $			V _{CE(sat)}	- -	0.4 0.75	Vdc
Base - Emitter Saturation Vo	V _{BE(sat)}	0.75 -	0.95 1.2	Vdc		
SMALL-SIGNAL CHARAC	TERISTICS					
Current-Gain - Bandwidth	Product (I	C = 20 mAdc, V _{CE} = 10 Vdc, f = 100 MHz)	f _T	250	_	MHz
Collector-Base Capacitance)	(V _{CB} = 5.0 Vdc, I _E = 0, f = 1.0 MHz)	C _{cb}	-	6.5	pF
Emitter-Base Capacitance		(V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)	C _{eb}	-	30	pF
Input Impedance	(I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{ie}	1.0	15	kΩ
Voltage Feedback Ratio	($I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h _{re}	0.1	8.0	X 10 ⁻⁴
Small-Signal Current Gain (I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)		I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	40	500	-
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)			h _{oe}	1.0	30	μmhos
SWITCHING CHARACTER	ISTICS					
Delay Time (V _{CC} = 30 Vdc, V _{BE} = 2.0 Vdc,		t _d	_	15	ns	
Rise Time	I _C = 150 mAdc, I _{B1} = 15 mAdc)		t _r	-	20	ns
Storage Time	(V _{CC} = 30 Vdc, I	C = 150 mAdc,	t _s	-	225	ns
Fall Time	$I_{B1} = I_{B2} = 15 \text{ m/}$	Adc)	t _f	_	30	ns

^{1.} Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]
2N4401	TO-92	5000 Units / Bulk
2N4401G	TO-92 (Pb-Free)	5000 Units / Bulk
2N4401RLRA	TO-92	2000 / Tape & Reel
2N4401RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
2N4401RLRMG	TO-92 (Pb-Free)	2000 / Tape & Ammo Box
2N4401RLRP	TO-92	2000 / Tape & Ammo Box
2N4401RLRPG	TO-92 (Pb-Free)	2000 / Tape & Ammo Box

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

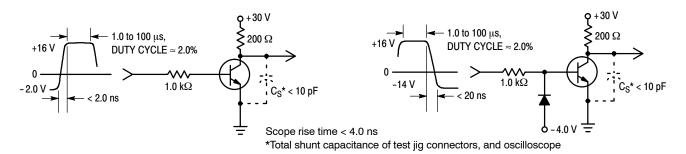


Figure 1. Turn-On Time

Figure 2. Turn-Off Time

Figure 4. Charge Data

TRANSIENT CHARACTERISTICS

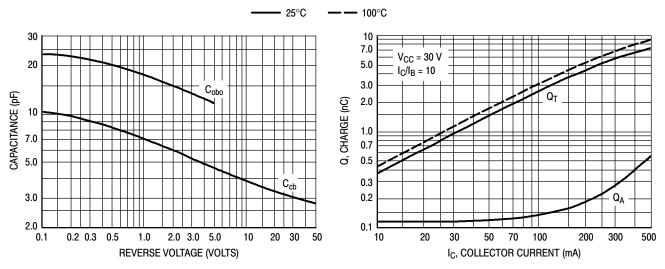
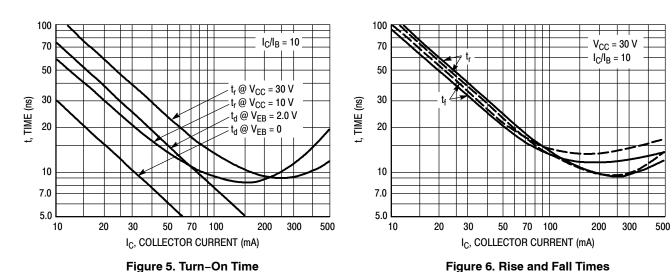
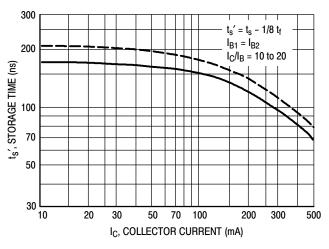


Figure 3. Capacitances



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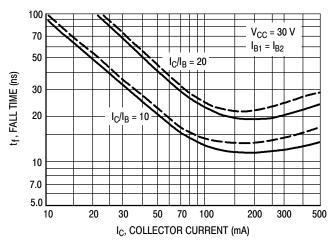
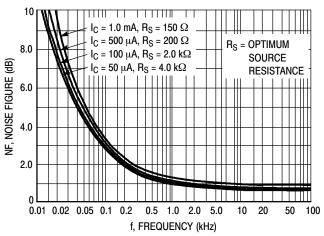


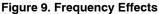
Figure 7. Storage Time

Figure 8. Fall Time

SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

 V_{CE} = 10 Vdc, T_A = 25°C; Bandwidth = 1.0 Hz





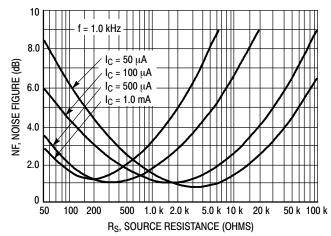


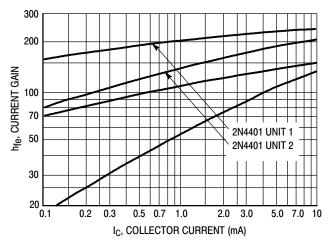
Figure 10. Source Resistance Effects

h PARAMETERS

 V_{CE} = 10 Vdc, f = 1.0 kHz, T_A = 25°C

This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were

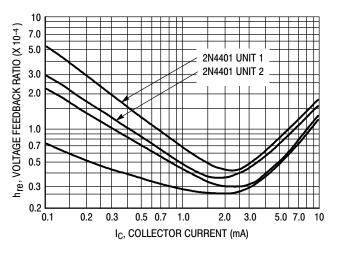
selected from the 2N4401 lines, and the same units were used to develop the correspondingly numbered curves on each graph.



50 k 2N4401 UNIT 1 2N4401 UNIT 2 h_{ie}, INPUT IMPEDANCE (OHMS) 20 k 10 k 5.0 k 2.0 k 1.0 k 500 0.2 0.5 0.7 1.0 2.0 7.0 10 IC, COLLECTOR CURRENT (mA)

Figure 11. Current Gain

Figure 12. Input Impedance



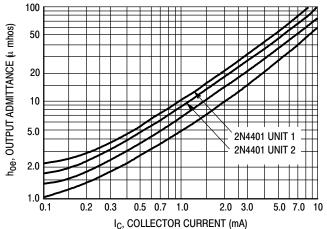


Figure 13. Voltage Feedback Ratio

Figure 14. Output Admittance

STATIC CHARACTERISTICS

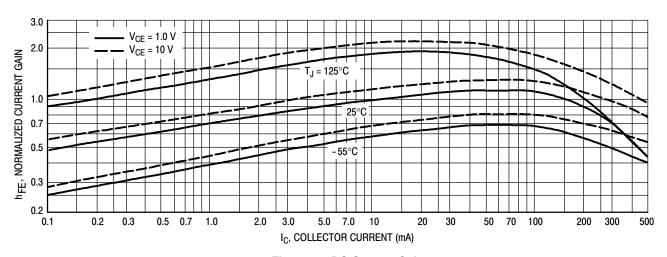


Figure 15. DC Current Gain

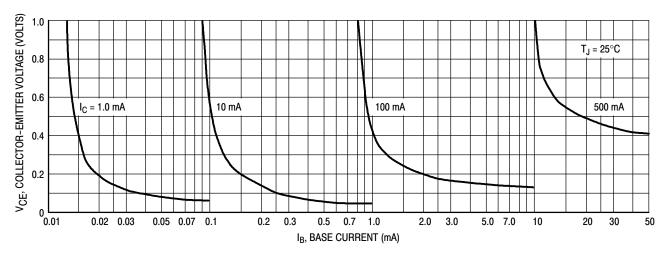


Figure 16. Collector Saturation Region

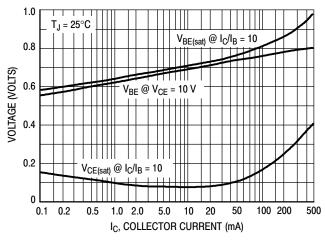


Figure 17. "On" Voltages

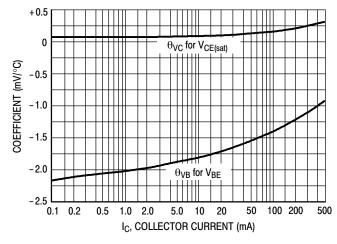
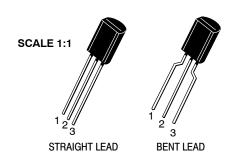
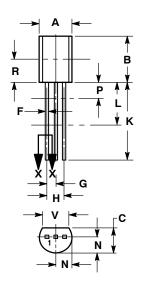


Figure 18. Temperature Coefficients



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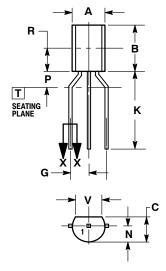
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STRAIGHT LEAD







BENT LEAD



NOTES:

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 CONTROLLING DIMENSION: INCHES.
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	AND L. DIMENSIONS D AND J APPLY BETWEEN DI-
	MENSIONS L AND K MINIMUM. THE LEAD
	DIMENSIONS ARE UNCONTROLLED IN DIMENSION
	P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.44	5.21
В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.46	0.53
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.018	0.024	0.46	0.61
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.135		3.43	
٧	0.135		3.43	

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME

- DIMENSIONING AND TOLERANCING PER ASME
 Y14.5M, 1994.
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 UNCONTROLLED.
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 AND L. DIMENSIONS D AND J APPLY BETWEEN
 DIMENSIONS L AND K MINIMUM. THE LEAD
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DIM	MIN	MAX	MIN	MAX
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С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.46	0.53
G	0.094	0.102	2.40	2.80
J	0.018	0.024	0.46	0.61
K	0.500		12.70	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.135		3.43	
٧	0.135		3.43	

STYLES ON PAGE 2

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ISSUE A

DATE 08 MAY 2012

STYLE 1: PIN 1. 2. 3.	EMITTER BASE COLLECTOR	STYLE 2: PIN 1. 2. 3.	BASE EMITTER COLLECTOR	STYLE 3: PIN 1. 2. 3.	ANODE ANODE CATHODE	STYLE 4: PIN 1. 2. 3.	CATHODE CATHODE ANODE	STYLE 5: PIN 1. 2. 3.	DRAIN SOURCE GATE
STYLE 6: PIN 1. 2. 3.	GATE SOURCE & SUBSTRATE DRAIN	STYLE 7: PIN 1. 2. 3.	SOURCE DRAIN GATE	STYLE 8: PIN 1. 2. 3.	DRAIN GATE SOURCE & SUBSTRATE	STYLE 9: PIN 1. 2. 3.	BASE 1 EMITTER BASE 2	STYLE 10: PIN 1. 2. 3.	
2. 3.	CATHODE & ANODE CATHODE	2. 3.	GATE MAIN TERMINAL 2	2. 3.		2. 3.	COLLECTOR BASE	2. 3.	CATHODE ANODE 2
STYLE 16: PIN 1. 2. 3.	ANODE GATE CATHODE	STYLE 17: PIN 1. 2. 3.	COLLECTOR BASE EMITTER	STYLE 18: PIN 1. 2. 3.	ANODE CATHODE NOT CONNECTED	STYLE 19: PIN 1. 2. 3.	GATE ANODE CATHODE	STYLE 20: PIN 1. 2. 3.	NOT CONNECTED CATHODE ANODE
PIN 1. 2.	COLLECTOR EMITTER	PIN 1.		PIN 1. 2.	GATE SOURCE DRAIN	PIN 1. 2.	EMITTER COLLECTOR/ANODE CATHODE	PIN 1. 2.	MT 1
3.	V _{CC} GROUND 2 OUTPUT	PIN 1. 2. 3.	MT SUBSTRATE MT	PIN 1. 2. 3.	ANODE GATE	PIN 1. 2. 3.	NOT CONNECTED ANODE CATHODE	PIN 1. 2.	DRAIN
2.	GATE DRAIN SOURCE	2.	BASE COLLECTOR EMITTER	2.	RETURN INPUT OUTPUT	2.	INPUT GROUND LOGIC		GATE COLLECTOR EMITTER

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FAN3111ESX FDMC86262P FDMD8530 FEBFL7733A_L53U021A FEBFOD8333 MM74HC138MX MMBZ5233B FOD3120SD
FPAB30BH60B FQP2N80 1.5KE16AG MT9V115EBKSTCH-GEVB NB6L295MNGEVB NB7L1008MNGEVB NC7WZ126K8X
NCL30000LED2GEVB NCN9252MUGEVB NCP1075PSRGEVB NCV4274CDT33RKG NCV887100D1R2G NDT2955 1N5339B
NSIC2030JBT3G NV890231MWTXGEVB CAT4101AEVB KA7818ETU S3JB 2SC5569-TD-E FEBFL7734_L55L008A 1V5KE39CA
FNB33060T AMIS30422DBGEVB AMIS3062XGEVK